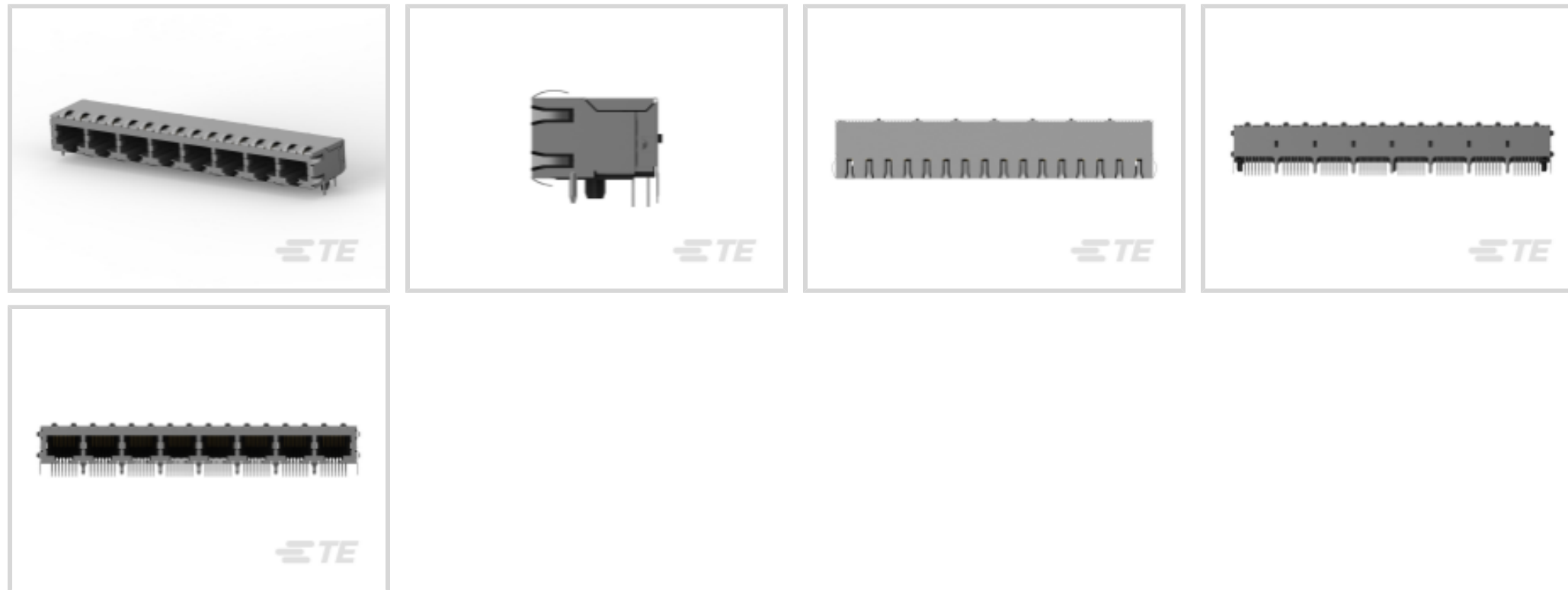


OEG Miniature Relay PCF

TE Internal #: 6339169-3

OEG Miniature Relay PCF, RJ45 Connectors, RJ45, Multiple Ports,
Port Matrix Configuration 1 x 8, RJ Type Jacks & Plugs[View on TE.com >](#)

Connectors > Modular Jacks & Plugs > RJ45 Connectors

Modular Jack & Plug Interface Type: **RJ45**Port Configuration: **Multiple Ports**Port Matrix Configuration: **1 x 8**Modular Jacks & Plugs Products: **RJ Type Jacks & Plugs**Connector Contact Density: **Standard**

Features

Product Type Features

| | |
|----------------------------------------|-----------------------|
| Connectors & Connector Components Type | Connector |
| Connector Product Type | Connector Assembly |
| Modular Jack & Plug Interface Type | RJ45 |
| Modular Jacks & Plugs Products | RJ Type Jacks & Plugs |
| Modular Connector Style | Jack |
| Grounding Options | PCB and Panel Ground |
| Connector & Contact Terminates To | Printed Circuit Board |

Configuration Features

| | |
|-----------------------------|----------------|
| Number of PCB Ground Tabs | 3 |
| Number of Panel Ground Tabs | 27 |
| Port Configuration | Multiple Ports |
| Port Matrix Configuration | 1 x 8 |
| Connector Contact Density | Standard |
| Multiple Port Configuration | Ganged |
| Status Indicator Type | None |



| | |
|----------------------------|-------------|
| Number of Positions | 8 |
| Number of Loaded Positions | 8 |
| PCB Mount Orientation | Right Angle |

Body Features

| | |
|--------------------------------|-----------------------|
| PCB Ground Tab Location | 4.57 mm[.18 in] |
| Shield Plating Material | Nickel |
| Shield Material | Copper Zinc Alloy |
| Modular Jack Latch Orientation | Standard - Latch Down |
| Connector Profile | Standard |

Contact Features

| | |
|------------------------------------------------|---------------------------|
| Contact Underplating Material | Nickel |
| PCB Contact Termination Area Plating Material | Tin |
| Contact Current Rating (Max) | 1 A |
| Contact Mating Area Plating Material | Gold |
| Contact Base Material | Phosphor Bronze |
| Contact Mating Area Plating Material Thickness | 1.27 μ m[50 μ in] |

Termination Features

| | |
|---------------------------------------------|-----------------------|
| Termination Method to Printed Circuit Board | Through Hole - Solder |
| Termination Post & Tail Length | 3.56 mm[.14 in] |

Mechanical Attachment

| | |
|-------------------------|-------------|
| Panel Mount Feature | Without |
| Connector Mounting Type | Panel Mount |

Housing Features

| | |
|-----------------------|-----------------|
| Mating Entry Location | Side |
| Centerline (Pitch) | 1.02 mm[.04 in] |
| Housing Color | Black |
| Housing Material | PCT Polyester |

Dimensions

| | |
|------------------|------------------|
| Connector Height | 13.71 mm[.54 in] |
|------------------|------------------|

Usage Conditions

| | |
|-----------------------------|---------------------------|
| Operating Temperature Range | -40 – 60 °C[-40 – 140 °F] |
|-----------------------------|---------------------------|

Operation/Application



| | |
|----------|-----|
| Shielded | Yes |
|----------|-----|

| | |
|---------------------|--------|
| Circuit Application | Signal |
|---------------------|--------|

Industry Standards

| | |
|------------------------|----------|
| UL Flammability Rating | UL 94V-0 |
|------------------------|----------|

| | |
|----------------------|-------|
| Performance Category | Cat 5 |
|----------------------|-------|

Packaging Features

| | |
|--------------------|----|
| Packaging Quantity | 10 |
|--------------------|----|

| | |
|------------------|------------------|
| Packaging Method | Box & Tray, Tray |
|------------------|------------------|

Other

| | |
|---------|----------------------------------------------------------------------------------------------------------------------|
| Comment | Recommended applications: Fast Ethernet, 10Base-T Ethernet, and 10/100 Base-T Ethernet (Cat 5 on two pair 1/2, 3/6). |
|---------|----------------------------------------------------------------------------------------------------------------------|

| | |
|--------------------------|---------------------|
| Shield Panel Ground Type | Wave panel grounds. |
|--------------------------|---------------------|

Product Compliance

[For compliance documentation, visit the product page on TE.com>](#)

| | |
|------------------------------|-----------|
| EU RoHS Directive 2011/65/EU | Compliant |
|------------------------------|-----------|

| | |
|-----------------------------|-----------|
| EU ELV Directive 2000/53/EC | Compliant |
|-----------------------------|-----------|

| | |
|-----------------------------------------------|-----------------------------------------|
| China RoHS 2 Directive MIIT Order No 32, 2016 | No Restricted Materials Above Threshold |
|-----------------------------------------------|-----------------------------------------|

| | |
|----------------------------------------|-------------------------------------------------------------------------------------------------------------------------------|
| EU REACH Regulation (EC) No. 1907/2006 | Current ECHA Candidate List: JAN 2021 (211) Candidate List Declared Against: JAN 2021 (211) Does not contain REACH SVHC |
|----------------------------------------|-------------------------------------------------------------------------------------------------------------------------------|

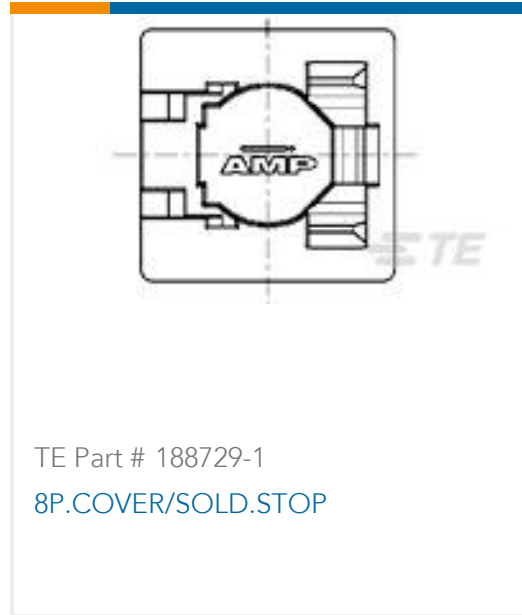
| | |
|-----------------|------------------------------------------------|
| Halogen Content | Not Low Halogen - contains Br or Cl > 900 ppm. |
|-----------------|------------------------------------------------|

| | |
|---------------------------|------------------------------|
| Solder Process Capability | Wave solder capable to 265°C |
|---------------------------|------------------------------|

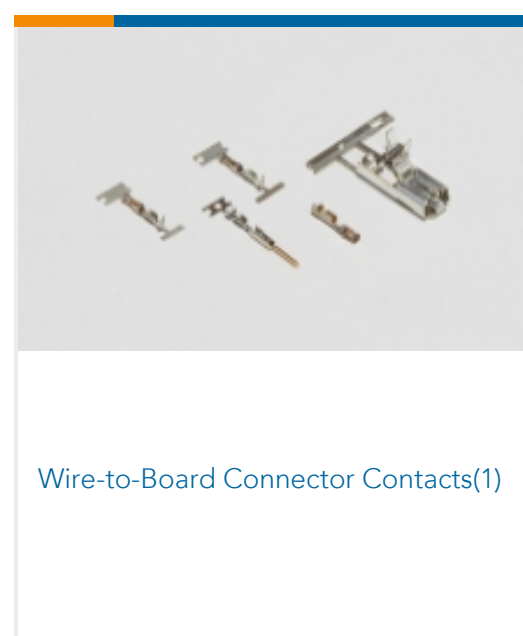
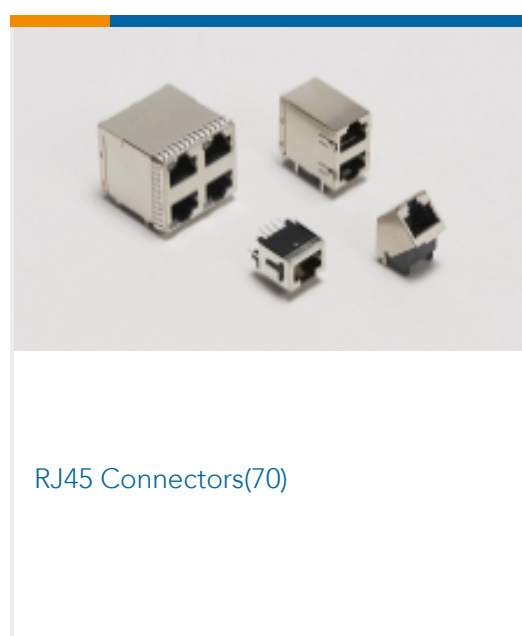
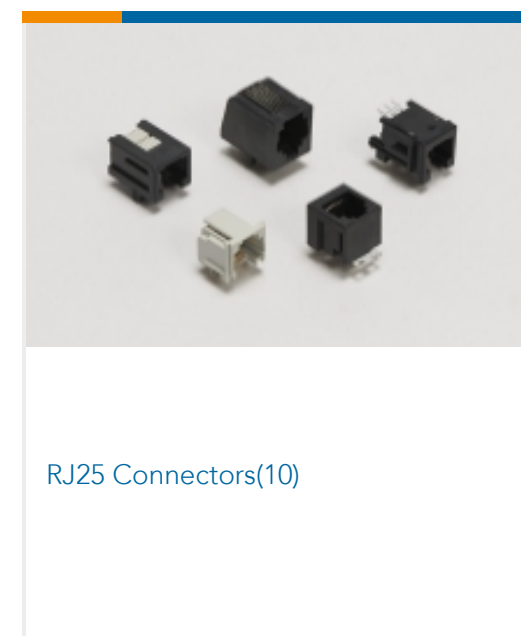
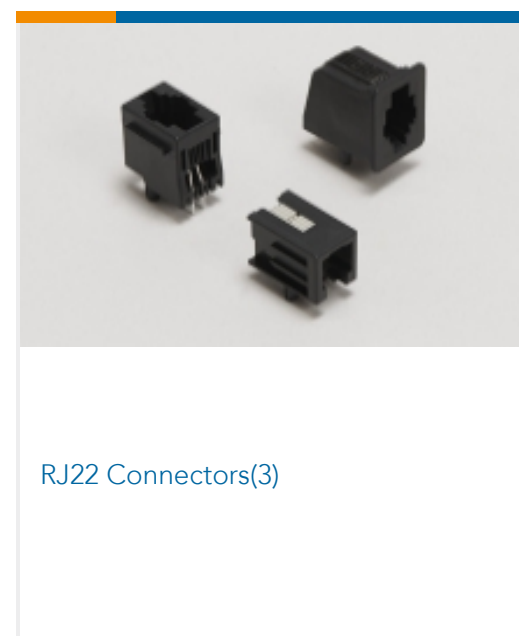
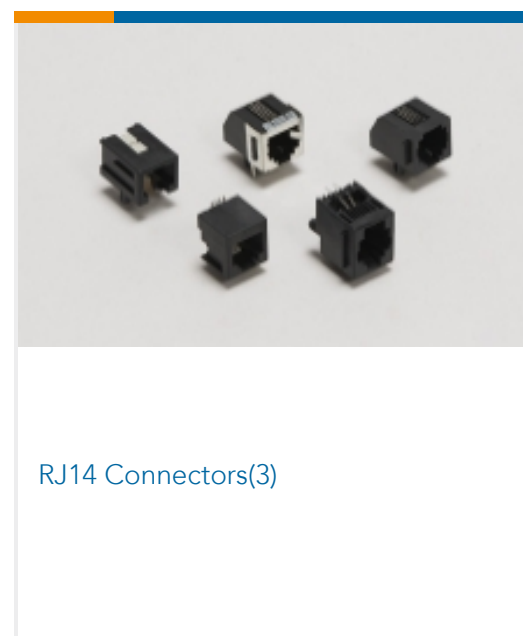
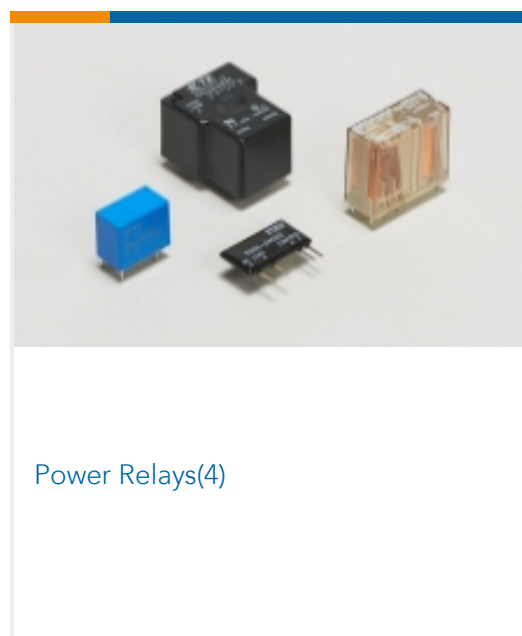
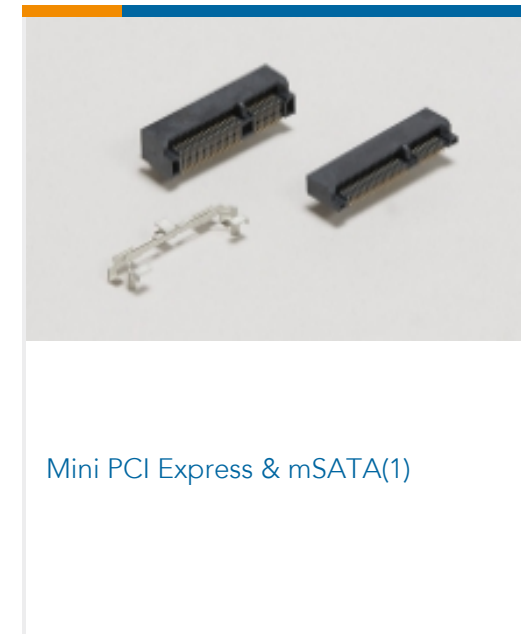
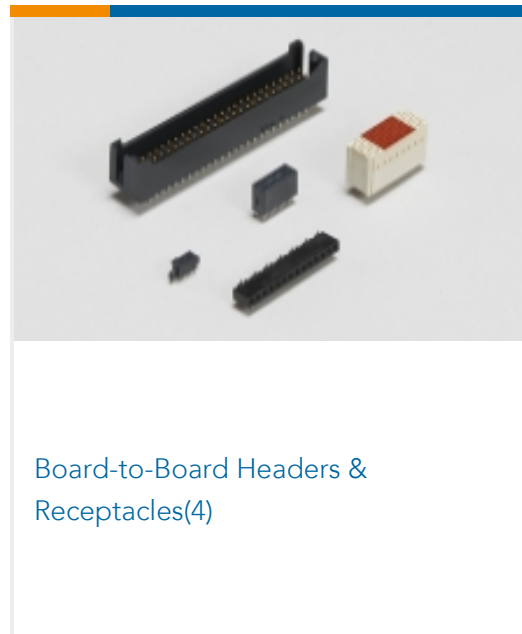
Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

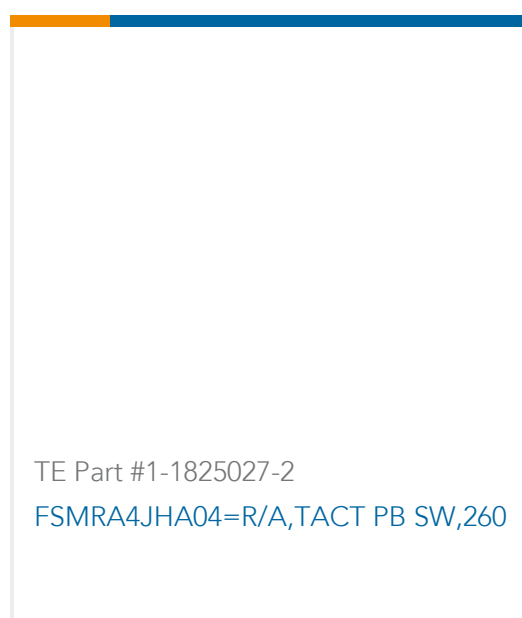
Compatible Parts



Also in the Series | OEG Miniature Relay PCF



Customers Also Bought



Documents

Product Drawings

[ASSY,SHLD,1X8,MJ,WAVE PNL](#)

English

CAD Files

[3D PDF](#)

3D

Customer View Model

[ENG_CVM_CVM_6339169-3_A.2d_dxf.zip](#)

English

Customer View Model

[ENG_CVM_CVM_6339169-3_A.3d_igs.zip](#)

English

Customer View Model

[ENG_CVM_CVM_6339169-3_A.3d_stp.zip](#)

English

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Product Specifications



Application Specification

English

Product Environmental Compliance

TE Material Declaration

English